

ASM AD 830

Vintage: 2010

Condition: Good working



Item		ASM
Model		AD830
Dimension	L X W X H	1670 X 1240 X 2080
Accuracy		±38um
Rotation		±3°
Cycle Time		0.25 Sec
Inspection		Pre/Post Capable
Die Size		150X150 ~ 1500X1500um
Lead Frame Size	Length	110 ~ 260mm
	Width	12.7 ~ 75mm
	Thickness	0.12 ~ 0.762mm
Magazine Size	Length	150 ~ 260mm
	Width	15.7 ~ 75mm
	Height	68 ~ 190mm
Bond Head	Bond/Pick Force	30 ~ 200g
	X-Resolution	0.2um
	Y-Resolution	0.5um
	Rotary Bond Head	Capable
Stack loader		Capable
Wafer Loader	Auto Change	Capable
Track	Width	12.7 ~ 75mm
PR System	Resolution	512 X 512
Wafer Table	Wafer Handling	6" (Option_Max 8")
Appendix		